L	Hits	S arch T xt	DB	Time stamp
Numb r				
1	246	430/198	USPAT;	2003/11/15
			US-PGPUB;	17:09
			DERWENT	
2	1998	(430/311).CCLS.	USPAT;	2003/11/15
			US-PGPUB;	17:09
			DERWENT	
3	1623	(430/330).CCLS.	USPAT;	2003/11/15
			US-PGPUB;	17:09
			DERWENT	
4	31	(((430/330).CCLS.) and (glass adj substrate))	USPAT;	2003/11/15
		and (conductor or " conductive paste")	US-PGPUB;	17:10
			DERWENT	
5	15	(((430/322).CCLS.) and (glass adj substrate))	USPAT;	2003/11/15
		and (conductor or " conductive paste")	US-PGPUB;	17:10
			DERWENT	
7	118	((174/250).CCLS.) and cross\$section	USPAT;	2003/11/15
			US-PGPUB;	17:11
			DERWENT	
8	291	((conductor or wir\$4 or line or resistor) near	USPAT;	2003/11/15
		pattern) and (corner same stress)	US-PGPUB;	17:12
			DERWENT	
6	162	((430/322).CCLS.) and (glass adj substrate)	USPAT;	2003/11/15
		,	US-PGPUB;	17:21
			DERWENT	
9	49	((438/610,669).CCLS.) and (sinter\$4 or	USPAT;	2003/11/15
		calcin\$4 or burn\$3)	US-PGPUB;	17:33
			DERWENT	